



TOHOKU  
UNIVERSITY



# 3rd CIES Technology Forum

Date

March 21-22  
2017

Venue

Station Conference Tokyo  
Sapia Tower 5F

1-7-12 Marunouchi, Chiyoda-ku, Tokyo

Chair: Tetsuo Endoh (Director of CIES, Tohoku Univ.)

»»» Program will be announced soon.

Reference

2nd CIES Technology Forum Program

**DAY 1** March 17, 2016

**International Symposium**

Invited  
Speakers

David Eggleston (GLOBALFOUNDRIES)  
Raj Jammy (Carl Zeiss)  
Junho Jeong (Samsung)  
Hideo Ohno (Tohoku Univ.)  
Chang-Man Park (Tokyo Electron)  
Yusuke Takayama (KEIHIN)  
Tetsuzo Ueda (Panasonic)  
Tadaaki Yamauchi (Renesas Electronics)

**DAY 2** March 18, 2016

**CIES Progress Report**

Welcome address Susumu Satomi (Tohoku Univ.)  
Address Yasuo Kishimoto (MEXT)

Jun Takashina (METI)  
Koichi Shinohara (JPO)

CIES overview Tetsuo Endoh (Tohoku Univ.)  
Progress Report Yasuo Ando (Tohoku Univ.)

Tetsuo Endoh (Tohoku Univ.)  
Yoichi Ohshima (Tohoku Univ.)  
Hideo Ohno (Tohoku Univ.)  
Yohei Shiokawa (Tohoku Univ.)  
Takahiro Hanyu (Tohoku Univ.)  
Naofumi Homma (Tohoku Univ.)

Closing Remarks Tetsuo Endoh (Tohoku Univ.)

**Tohoku University**  
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